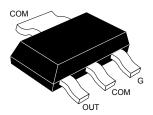
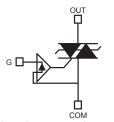


# 0.8 A - 800 V overvoltage protected AC switch (ACS™)



**SOT-223** 



COM Common drive reference to connect to the mains
OUT Output to connect to the load.
Gate input to connect to the controlle

Gate input to connect to the controller through gate resistor

| Product status link |  |
|---------------------|--|
| ACS108-8SN          |  |

| Product summary                     |       |  |
|-------------------------------------|-------|--|
| I <sub>T(RMS)</sub>                 | 0.8 A |  |
| V <sub>DRM</sub> , V <sub>RRM</sub> | 800 V |  |
| I <sub>GT</sub>                     | 10 mA |  |

#### **Features**

- Enables equipment to meet IEC 61000-4-5 surge with overvoltage crowbar technology
- High noise immunity against static dV/dt and IEC 61000-4-4 burst
- · Needs no external protection snubber or varistor
- Reduces component count by up to 80% and Interfaces directly with the microcontroller
- Common package tab connection supports connection of several alternating current switches on the same cooling pad
- V<sub>CL</sub> gives headroom before clamping then crowbar action

### **Applications**

- Alternating current on/off static switching in appliances and industrial control systems
- · Driving low power high inductive or resistive loads like:
  - relay, valve, solenoid, dispenser
  - pump, fan, low power motor, door lock, air flow dumper
  - lamp

### **Description**

The ACS108-8SN belongs to the AC switch range (built with A. S. D.® technology). This high performance switch can control a load of up to 0.8 A.

This device switch includes an overvoltage crowbar structure to absorb the inductive turn-off energy, and a gate level shifter driver to separate the digital controller from the main switch. It is triggered with a negative gate current flowing out of the gate pin.

Note: ®: A.S.D. is a registered trademark of STMicroelectronics

Note: TM: ACS is a trademark of STMicroelectronics



## 1 Characteristics

Table 1. Absolute maximum ratings (T<sub>amb</sub> = 25 °C, unless otherwise specified)

| Symbol                                     | Parameter   |                           | Value       | Unit             |
|--|---|---------------------------|-------------|------------------|
| 1  | On state rms surrent (full sine ways) C = Fem²  | T <sub>amb</sub> = 76 °C  | 0.0         | А                |
| I <sub>T(RMS)</sub>                        | On-state rms current (full sine wave), S = 5cm <sup>2</sup>   | T <sub>tab</sub> = 104 °C | 0.8         |                  |
| Non repetitive surge peak on-state current |   | t <sub>p</sub> = 20 ms    | 13          | Α                |
| I <sub>TSM</sub>                           | $T_j$ initial = 25 °C, (full cycle sine wave) $I^2t 	 I^2t 	 I^2t 	 for fuse selection$   | t <sub>p</sub> = 16.7 ms  | 13.7        |                  |
| I <sup>2</sup> t                           | $l^2t$ for fuse selection $t_p = 10 \text{ ms}$   |                           | 1.1         | A <sup>2</sup> s |
| dl/dt                                      | Critical rate of rise on-state current $I_G = 2 \times I_{GT}$ , tr $\leq 100 \text{ ns}$ $f = 120 \text{ Hz}$ , $T_j = 125 \text{ °C}$ |                           | 100         | A/µs             |
| $V_{PP}^{(1)}$                             | Non repetitive line peak pulse voltage  |                           | 2           | kV               |
| P <sub>G(AV)</sub>                         | Average gate power dissipation  | T <sub>j</sub> = 125 °C   | 0.1         | W                |
| $V_{GM}$                                   | Peak positive gate voltage  | T <sub>j</sub> = 125 °C   | 10          | V                |
| I <sub>GM</sub>                            | Peak gate current ( $t_p$ = 20 $\mu$ s) $T_j$ = 125 °C  |                           | 1           | Α                |
| T <sub>stg</sub>                           | Storage temperature range   |                           | -40 to +150 | °C               |
| Tj   | Operating junction temperature range  |                           | -30 to +125 | °C               |

according to test described by standard IEC 61000-4-5, see Figure 17. Overvoltage ruggedness test circuit for resistive and inductive loads, T<sub>amb</sub> = 25 °C (conditions equivalent to IEC 61000-4-5 standard) for conditions

Table 2. Electrical characteristics ( $T_j = 25$  °C, unless otherwise specified)

| Symbol  | Test conditions  | Quadrant | Va   | lue  | Unit |
|---|--|----------|------|------|------|
| I <sub>GT</sub> <sup>(1)</sup>                | V <sub>OUT</sub> = 12 V, R <sub>I</sub> = 33 Ω                             | II - III | Max. | 10   | mA   |
| V <sub>GT</sub> = 12 V, R <sub>L</sub> = 33 Ω |  | 11 - 111 | Max. | 1.0  | V    |
| $V_{GD}$                                      | $V_{OUT} = V_{DRM}$ , $R_L = 3.3 \text{ k}\Omega$ , $T_j = 125 \text{ °C}$ | 11 - 111 | Min. | 0.15 | V    |
| I <sub>H</sub>                                | I <sub>OUT</sub> = 100 mA  | Max.     | 10   | mA   |      |
| IL  | I <sub>G</sub> = 1.2 x I <sub>GT</sub>                                     | Max.     | 25   | mA   |      |
| dV/dt   | $V_{OUT}$ = 402 V, gate open, $T_j$ = 125 °C                               |          |      |      | V/µs |
| uv/ut   | V <sub>OUT</sub> = 536 V, gate open, T <sub>j</sub> = 125 °C               |          |      |      | v/µS |
| (dl/dt)c                                      | Without snubber (15 V/µs), T <sub>j</sub> = 125 °C, turn-off time ≤20 ms   |          |      | 2    | A/ms |
| V <sub>CL</sub>                               | $I_{CL} = 0.1 \text{ mA}, t_p = 1 \text{ ms}$                              | Min.     | 850  | V    |      |

<sup>1.</sup> Minimum  $I_{GT}$  is guaranteed at 10% of  $I_{GT}$  max.

DS12893 - Rev 2 page 2/14



#### **Table 3. Static electrical characteristics**

| Symbol                         | Test condition   | Test conditions         |        |      |    |
|--------------------------------|--|-------------------------|--------|------|----|
| V <sub>TM</sub> <sup>(1)</sup> | I <sub>TM</sub> = 1.1 A, t <sub>p</sub> = 500 μs       | T <sub>j</sub> = 25 °C  | Max.   | 1.3  | V  |
| V <sub>TO</sub> <sup>(1)</sup> | Threshold voltage                                      | T <sub>j</sub> = 125 °C | Max.   | 0.85 | V  |
| R <sub>d</sub> <sup>(1)</sup>  | Dynamic resistance                                     | T <sub>j</sub> = 125 °C | Max.   | 300  | mΩ |
| I <sub>DRM</sub>               | V <sub>OUT</sub> = V <sub>DRM</sub> / V <sub>RRM</sub> | T <sub>j</sub> = 25 °C  | Max.   | 2    | μA |
| I <sub>RRM</sub>               | VOUI - VDRIM VRRIM                                     | T <sub>j</sub> = 125 °C | ividX. | 0.2  | mA |

<sup>1.</sup> For both polarities of OUT pin referenced to COM pin

**Table 4. Thermal characteristics** 

| Symbol               | Parame               | Max. value            | Unit |    |      |
|----------------------|----------------------|-----------------------|------|----|------|
| R <sub>th(j-t)</sub> | Junction to tab (AC) |                       |      | 25 | °C/W |
| R <sub>th(j-a)</sub> | Junction to ambient  | S = 5 cm <sup>2</sup> | Max. | 60 | C/VV |

DS12893 - Rev 2 page 3/14



### 1.1 Characteristics (curves)

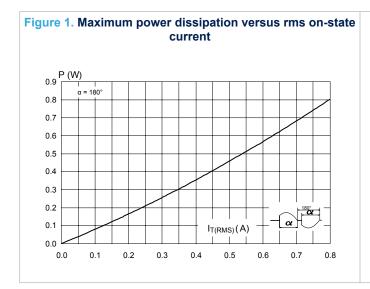


Figure 2. On-state rms current versus case temperature

0.9

1T(RMS) (A)

0.8

0.7

0.6

0.5

0.4

0.3

0.2

0.1

0.0

0 25 50 75 100 125

Figure 3. On-state rms current versus ambient temperature (free air convection)  $I_{T(RMS)}(A)$ 0.9 α =180° 0.8 SOT-223 0.7 0.6 0.5 0.4 0.3 0.2 Single layer Printed circuit board FR4 0.1 T<sub>a</sub> °C Natural convection 0.0 0 125

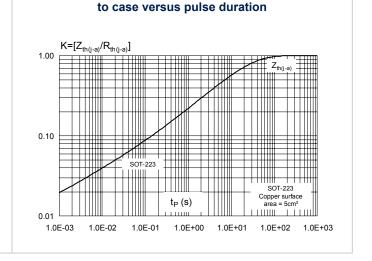


Figure 4. Relative variation of thermal impedance junction

DS12893 - Rev 2 page 4/14



Figure 5. Relative variation of holding and latching current versus junction temperature

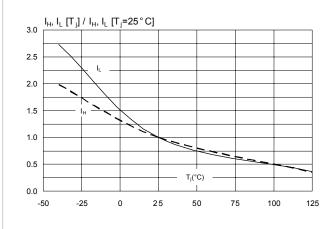


Figure 6. Relative variation of  $I_{GT}$  and  $V_{GT}$  versus junction temperature

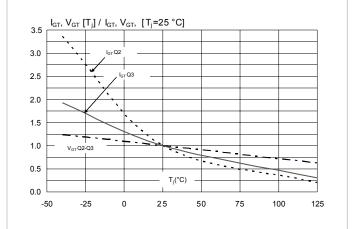


Figure 7. Surge peak on-state current versus number of cycles

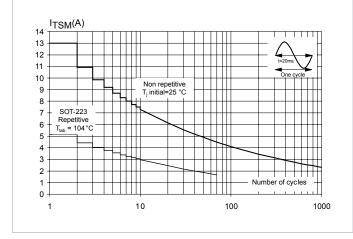


Figure 8. Non repetitive surge peak on-state current for a sinusoidal pulse

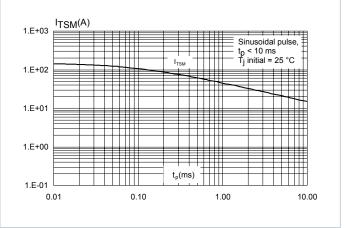


Figure 9. On-state characteristics (maximum values)

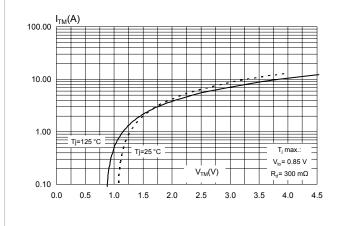
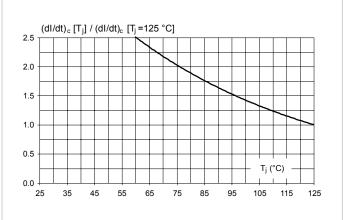


Figure 10. Relative variation of critical rate of decrease of main current versus junction temperature



DS12893 - Rev 2 page 5/14



Figure 11. Relative variation of static dV/dt immunity versus junction temperature (typical values above 5 kV/μs)

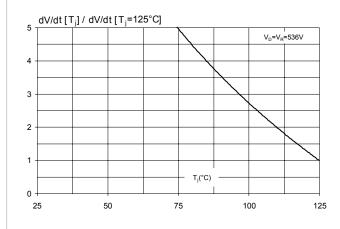


Figure 12. Relative variation of leakage current versus junction temperature

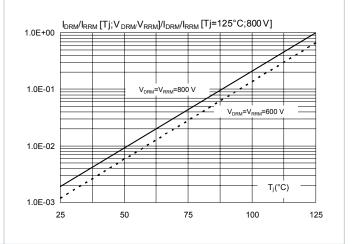


Figure 13. Relative variation of critical rate of decrease of main current (di/dt)c versus (dV/dt)c

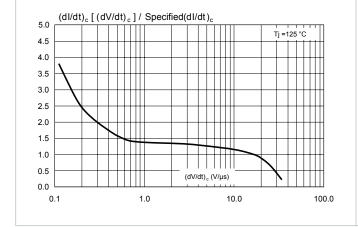
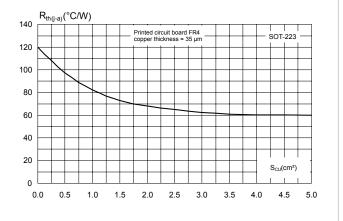


Figure 14. Thermal resistance junction to ambient versus copper surface under tab



DS12893 - Rev 2 page 6/14



## 2 Alternating current mains switch - basic application

The ACS108 switch is triggered by a negative gate current flowing from the gate pin G. The switch can be driven directly by the digital controller through a resistor as shown in Figure 15. Typical application schematic

Thanks to its overvoltage protection and turn-off commutation performance, the ACS108 switch can drive a small power high inductive load with neither varistor nor additional turn-off snubber.

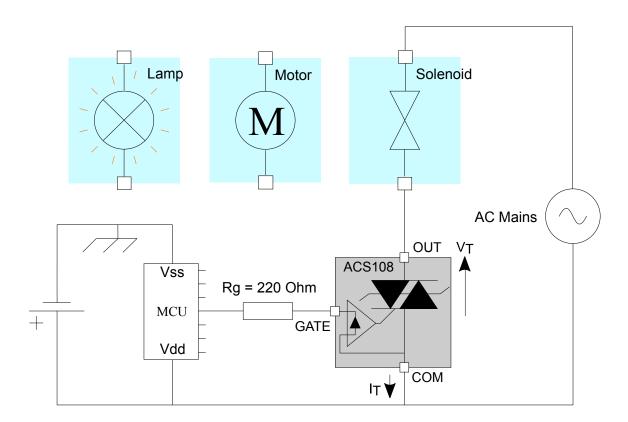


Figure 15. Typical application schematic

### 2.1 Protection against overvoltage: the best choice is ACS

In comparison with standard Triacs the ACS108 is over-voltage self-protected, as specified by the parameter  $V_{CL}$ . This feature is useful in two operating conditions: in case of turn-off of very inductive load, and in case of surge voltage that can occur on the electrical network.

#### 2.1.1 High inductive load switch-off: turn-off overvoltage clamping

With high inductive and low rms current loads the rate of decrease of the current is very low. An overvoltage can occur when the gate current is removed and the OUT current is lower than I<sub>H</sub>.

As shown in Figure 16. Switching off of a high inductive load - typical clamping capability of ACS108 ( $T_{amb}$  = 25 °C), at the end of the last conduction half-cycle, the load current decreases ① . The load current reaches the holding current level  $I_H$  ② , and the ACS turns off ③ . The water valve, as an inductive load (up to 15 H), reacts as a current generator and an overvoltage is created, which is clamped by the ACS ④ . The current flows through the ACS avalanche and decreases linearly to zero. During this time, the voltage across the switch is limited to the clamping voltage  $V_{CL}$ . The energy stored in the inductance of the load is dissipated in the clamping section that is

DS12893 - Rev 2 page 7/14



designed for this purpose. When the energy has been dissipated, the ACS voltage falls back to the mains voltage value (230 V rms, 50 Hz) ⑤.

Figure 16. Switching off of a high inductive load - typical clamping capability of ACS108 (T<sub>amb</sub> = 25 °C)

#### 2.1.2 Alternating current mains transient voltage ruggedness

the current).

The ACS108 switch is able to withstand safely the AC mains transients either by clamping the low energy spikes or by breaking-over when subjected to high energy shocks, even with high turn-on current rises.

The test circuit shown in Figure 17. Overvoltage ruggedness test circuit for resistive and inductive loads,  $T_{amb} = 25$  °C (conditions equivalent to IEC 61000-4-5 standard) is representative of the final ACS108 application, and is also used to test the AC switch according to the IEC 61000-4-5 standard conditions. Thanks to the load limiting the current, the ACS108 switch withstands the voltage spikes up to 2 kV above the peak mains voltage. The protection is based on an overvoltage crowbar technology. Actually, the ACS108 breaks over safely as shown in Figure 18. Typical current and voltage waveforms across the ACS108 (+2 kV surge, IEC 61000-4-5 standard). The ACS108 recovers its blocking voltage capability after the surge (switch off back at the next zero crossing of

Such non-repetitive tests can be done 10 times on each AC mains voltage polarity.

DS12893 - Rev 2 page 8/14



Figure 17. Overvoltage ruggedness test circuit for resistive and inductive loads, T<sub>amb</sub> = 25 °C (conditions equivalent to IEC 61000-4-5 standard)

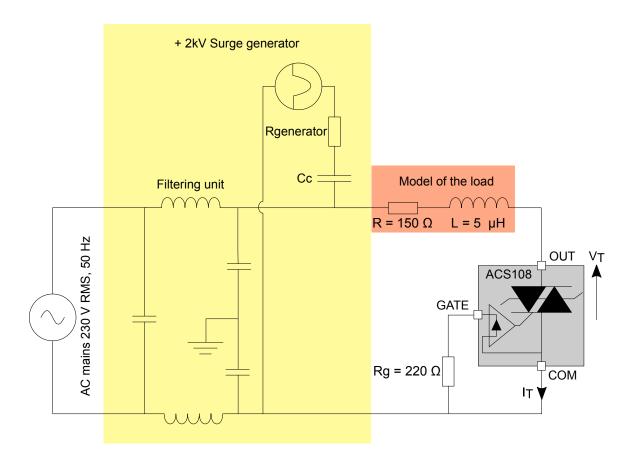
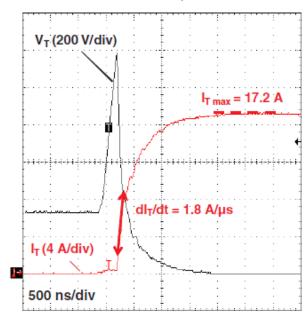


Figure 18. Typical current and voltage waveforms across the ACS108 (+2 kV surge, IEC 61000-4-5 standard)



DS12893 - Rev 2 page 9/14



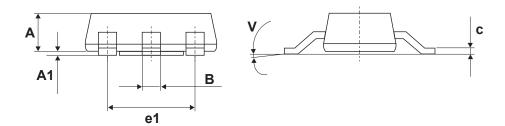
# 3 Package information

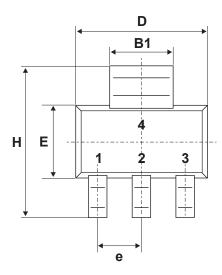
In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK packages, depending on their level of environmental compliance. ECOPACK specifications, grade definitions and product status are available at: <a href="https://www.st.com">www.st.com</a>. ECOPACK is an ST trademark.

## 3.1 SOT-223 package information

- Epoxy meets UL94, V0
- Lead free plating + halogen-free molding resin

Figure 19. SOT-223 package outline





DS12893 - Rev 2 page 10/14

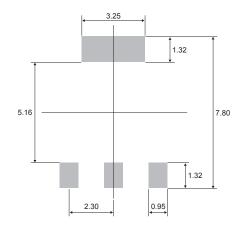


Table 5. SOT-223 package mechanical data

|      |             |      |      | Dimensions            |        |        |
|------|-------------|------|------|-----------------------|--------|--------|
| Ref. | Millimeters |      |      | Inches <sup>(1)</sup> |        |        |
|      | Min.        | Тур. | Max. | Min.                  | Тур.   | Max.   |
| А    |             |      | 1.80 |                       |        | 0.0709 |
| A1   |             | 0.02 | 0.10 |                       | 0.0008 | 0.0039 |
| В    | 0.60        | 0.70 | 0.85 | 0.024                 | 0.0276 | 0.0335 |
| B1   | 2.90        | 3.00 | 3.15 | 0.114                 | 0.1181 | 0.1240 |
| С    | 0.24        | 0.26 | 0.35 | 0.009                 | 0.0102 | 0.0138 |
| D    | 6.30        | 6.50 | 6.70 | 0.248                 | 0.2559 | 0.2638 |
| е    |             | 2.3  |      |                       | 0.0906 |        |
| e1   |             | 4.6  |      |                       | 0.1811 |        |
| Е    | 3.30        | 3.50 | 3.70 | 0.130                 | 0.1378 | 0.1457 |
| Н    | 6.70        | 7.00 | 7.30 | 0.264                 | 0.2756 | 0.2874 |
| V    |             |      |      | 10° max.              |        |        |

<sup>1.</sup> Inches only for reference

Figure 20. SOT-223 footprint (dimensions in mm)

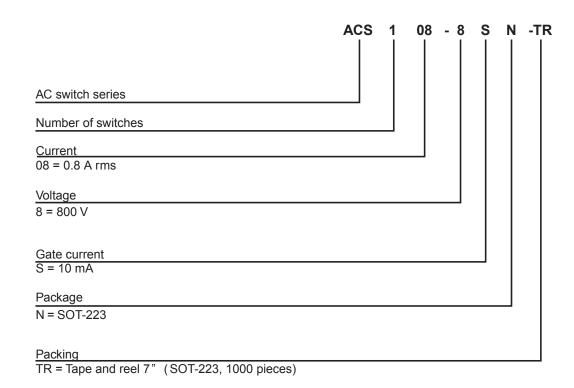


DS12893 - Rev 2 page 11/14



# 4 Ordering information

Figure 21. Ordering information scheme



**Table 6. Ordering information** 

| Order code    | Marking                   | Package | Weight | Base qty. | Packing mode  |
|---------------|---------------------------|---------|--------|-----------|---------------|
| ACS108-8SN-TR | ACS 108 8S <sup>(1)</sup> | SOT-223 | 0.11 g | 1000      | Tape and reel |

1. first row = ACS, second row = 108, third row = 8S

DS12893 - Rev 2 page 12/14



# **Revision history**

**Table 7. Document revision history** 

| Date        | Version | Changes  |
|-------------|---------|--|
| 07-Feb-2019 | 1       | Initial release.                               |
| 08-Aug-2019 | 2       | Updated Section Product status link / summary. |

DS12893 - Rev 2 page 13/14



#### **IMPORTANT NOTICE - PLEASE READ CAREFULLY**

STMicroelectronics NV and its subsidiaries ("ST") reserve the right to make changes, corrections, enhancements, modifications, and improvements to ST products and/or to this document at any time without notice. Purchasers should obtain the latest relevant information on ST products before placing orders. ST products are sold pursuant to ST's terms and conditions of sale in place at the time of order acknowledgement.

Purchasers are solely responsible for the choice, selection, and use of ST products and ST assumes no liability for application assistance or the design of Purchasers' products.

No license, express or implied, to any intellectual property right is granted by ST herein.

Resale of ST products with provisions different from the information set forth herein shall void any warranty granted by ST for such product.

ST and the ST logo are trademarks of ST. For additional information about ST trademarks, please refer to <a href="https://www.st.com/trademarks">www.st.com/trademarks</a>. All other product or service names are the property of their respective owners.

Information in this document supersedes and replaces information previously supplied in any prior versions of this document.

© 2019 STMicroelectronics - All rights reserved

DS12893 - Rev 2 page 14/14